ECEN 5613 Fall 2023

Embedded System Design Lab #1 Signoff Sheet - Part 1&2 Elements

Week #1 8/28/2023

You will need to obtain the signature of your TA on the following items in order to receive credit.

The Part 1 & Part 2 Elements of Lab #1 should be completed and signed off by Friday, Sept. 15, 2023 in order to give you time to complete the Part 3 Elements upon receipt of your parts kit. All signoffs are due by Friday, Sept. 22, 2023. You need to submit both of your signoff sheets and other required elements by 11:59pm Sunday, Sept. 24, 2023. Labs completed after the signature due date or submitted after the submission due date will usually receive grade reductions, but there is leniency on Lab #1.

Print your name below and then demonstrate your working hardware/firmware in order to obtain the necessary signatures. All items must be completed to get a signature, but partial credit is given for

any particular grade; it merely indicat									
Student Name: SHRUTHI THAL	LAPALLY								
Checklist									
Student demonstrates detailed knowledge of an 8051 simulator or debugger (including changing									
register values, editing data memory, using breakpoints, single stepping, uses /overlay option, etc.) Student assembly program works correctly									
Student demonstrates detailed knowledge of WinCUPL and WinSim, logic equations correct									
Student demonstrates detailed knowledge of the final project assignment and discusses any questions with the TAs.									
Student Answers to Lab Questions									
1. How many bytes of code space does your program require?									
(Show how you arrived at your answer.)									
Code Size? 5 65ytes.									
2. How long did your program take to execute for X=0x93 and Y=0x0A? Assume an 11.0592 MHz									
clock and include the instructions executed from the beginning until you reach the ENDLOOP label. Show the TA your detailed calculations on the code listing during your signoff.									
Execution Time? 59,6405									
			09	115/2023					
Instructor/TA Comments: □ □ □ TA signature and date									
FOR INSTRUCTOR HEE ONLY	Not	Poor/Not	Meets Exceeds						
FOR INSTRUCTOR USE ONLY SPLD code	Applicable	Complete	Requirements Requirements	Outstanding					
Assembly Language Code Style Required Elements functionality	Ä	Ħ							
Sign-off done without excessive retries Student understanding and skills		Ä		П					
Overall Demo Quality									

Comments:

Overall Demo Quality

NOTE: This submission sheet should be the top/first sheet of your submission.

Submission Sheet 1



C+3 Folder returne correct IF Assembly is well-communed
IF All coon work correctly except for oddress 0x23 and B >= 80H 0x 1000 000 00 00 PRIC 0x 0000 000 00 00 000 . - och CHJ WimCUPL/WimSim correct.

ECEN 5613 Fall 2023

Embedded System Design Lab #1 Signoff Sheet - Part 3 Elements

Week #1 8/28/2023

Print your name below, answer the questions, and then demonstrate your working hardware in order to obtain the necessary signatures. All items must be completed to get a signature.

Stu	dent Name: SHRUTHI THAC	LAPALLY	-								
Checklist Schematic of acceptable quality, Student name on board in permanent ink Pins and signals labeled, decoupling capacitors, and two 28-pin wire wrap sockets present on board: Mounting hardware present (e.g. standoffs or an enclosure) Power switch and LED, voltage regulator functional, power jack present Power-on Reset (RC) and Run-time Reset (pushbutton), 8051 bypass cap is present RS-232 connector mounted, 74LS373 transparent latch wired Logic outputs correct (e.g. SPLD generation of /READ and /CSPERIPH; view SPLD code) Student displays good knowledge of oscilloscope Peak to peak noise measured across processor VCC and GND is < 800mV Oscillator functional (check for correct ALE/XTAL2 signals after power on-off cycles) EFM8 & ARM development boards functional, student can demonstrate the basic software.											
Student Answers to Lab Questions											
1.	. What voltage is present at the regulator input? Use a digital multimeter 7.6 V										
2.	What voltage is present at the regulator output? Use a digital multimeter. 439 \										
3.	. What peak to peak noise is present across the processor VCC and GND? Use an oscilloscope.										
	Measured value at processor package pins on top side of board:										
	Measured value at wire wrap socket pins on bottom side of board:										
4.	How long is the processor held in reset after the run-time reset pushbutton is released? Use an oscilloscope and try to measure the time between the release of the pushbutton and the time when noise from ALE is observed on the RST signal.										
	Measured value: 276 ms										
5.	5. What frequency is present at the ALE pin? Use an oscilloscope										
				Au	12 2 2022 E						
Instructor/TA Comments: \[\begin{array}{cccccccccccccccccccccccccccccccccccc											
FO	R INSTRUCTOR USE ONLY	Not Applicable	Poor/Not Complete	Meets Requirements	Exceeds Requirements	Outstanding					
Han Req Sign	ematics, SPLD code dware physical implementation uired Elements functionality n-off done without excessive retries dent understanding and skills		00000	عاطاطاطاط							
	erall Demo Quality										
046	To Committee of the Com										

Comments:

NOTE: This submission sheet should be the second sheet of your submission.

Part 3 Comments

[t] Hardware Implementation

[t] Decoupling capacitors added

[-] Label not present for IC

[t] Good knowledge of oscilloscope & logic analyzer.

[t] STM32 code

Submission Sheet

Instructions: Print your name below and sign the honor code pledge. Separate the signoff and submission sheets from the rest of the lab and turn in a scan (or clear picture) of these signed forms, the items in the checklist below, and the answers to any applicable lab questions in order to receive credit for your work. No cover sheet please. Submit all items electronically via Canvas to reduce paper usage. Canvas is https://canvas.colorado.edu.

Remember, in addition to the items listed on the signoff checklist, be sure to review the lab for additional requirements for submission, including:

- Scan of signed and dated Part 1 & 2 Elements signoff sheet as the top sheet (No cover sheet please)
- Scan of signed and dated Part 3 Elements signoff sheet as the second sheet
- Scan of submission sheet with signed honor code pledge as the third sheet
- PDF of complete and accurate final schematic of acceptable quality (all components shown).
- Fully, neatly, and clearly commented assembly code.
- Clear high-resolution pictures of the top and bottom sides of your 8051 board. Must be able to read any silkscreen/labels on the board as well as zoom in and see the solder joints and wire wraps.

Make copies of your code, SPLD code, and schematic files and save them as an archive.

Student Name: Shruthi Thallapally

Honor Code Pledge: "On my honor, as a University of Colorado student, I have neither given nor received unauthorized assistance on this work. I have clearly acknowledged work that is not my own."

Student Signature: T. Shruttii

How much power is dissipated in the regulator, assuming a load current of 210mA? Assume that
the regulator is drawing the max quiescent current shown in the data sheet (use the correct data sheet
for the regulator you have on your board). Neatly show all your work.

Calculated value: 593.7mW

Comments:

NOTE: This submission sheet should be the third sheet of your submission.